

4A, 500V

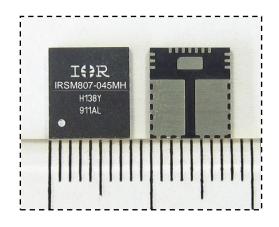
# Half-Bridge Module For Small Appliance Motor Drive Applications

## Description

IRSM807-045MH is a 4A, 500V half-bridge module designed for advanced appliance motor drive applications such as energy efficient fans and pumps. IR's technology offers an extremely compact, high performance half-bridge topology in an isolated package. This advanced IPM offers a combination of IR's low  $R_{\rm DS(on)}$  Trench FREDFET technology and the industry benchmark half-bridge high voltage, rugged driver in a small PQFN package. At only 8x9mm and featuring integrated bootstrap functionality, the compact footprint of this surface-mount package makes it suitable for applications that are space-constrained. IRSM807-045MH functions without a heat sink.

#### **Features**

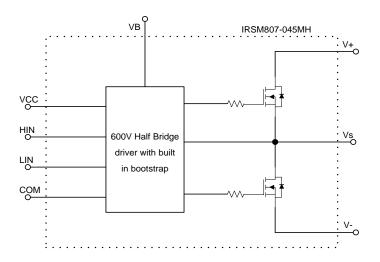
- Integrated gate drivers and bootstrap functionality
- Suitable for sinusoidal or trapezoidal modulation
- Low R<sub>DS(on)</sub> Trench FREDFET
- Under-voltage lockout for both channels
- Matched propagation delay for all channels
- Optimized dV/dt for loss and EMI trade offs
- 3.3V input logic compatible
- Active high HIN and LIN
- Isolation 1500VRMS min



Base Part Number	Bookaga Tyma	Standard Pack		Orderable Part Number	
base Fart Number	Package Type	Form	Quantity		
IRSM807-045MH	32L PQFN 8x9	Tray	1300	IRSM807-045MH	
IK5IVI807-045IVIH		Tape & Reel	2000	IRSM807-045MHTR	



#### **Internal Electrical Schematic**



## **Absolute Maximum Ratings**

Absolute maximum ratings indicate sustained limits beyond which damage to the module may occur. These are not tested at manufacturing. All voltage parameters are absolute voltages referenced to V<sub>SS</sub> unless otherwise stated in the table. The thermal resistance rating is measured under board mounted and still air conditions.

Symbol	Description	Min	Max	Unit
BV <sub>DSS</sub>	FREDFET Blocking Voltage		500	V
I <sub>O</sub> @ T <sub>C</sub> =25°C	DC Output Current		4	^
I <sub>OP</sub>	Pulsed Output Current (Note 1)		35	A
P <sub>d</sub>	Maximum Power Dissipation per FREDFET @ T <sub>C</sub> =25°C		50	W
V <sub>ISO</sub>	Isolation Voltage (1min) (Note 2)		1500	V <sub>RMS</sub>
T <sub>J</sub>	Operating Junction Temperature	-40	150	°C
T <sub>L</sub>	Lead Temperature (Soldering, 30 seconds)		260	°C
Ts	Storage Temperature	-40	150	°C
V <sub>S1,2,3</sub>	High Side Floating Supply Offset Voltage	V <sub>B1,2,3</sub> - 20	V <sub>B1,2,3</sub> +0.3	V
V <sub>B1,2,3</sub>	High Side Floating Supply Voltage	-0.3	500	V
Vcc	Low Side and Logic Supply voltage	-0.3	20	V
V <sub>IN</sub>	Input Voltage of LIN, HIN	V <sub>SS</sub> -0.3	V <sub>CC</sub> +0.3	V

Note 1: Pulse Width =  $100\mu s$ ,  $T_C = 25^{\circ}C$ , Duty=1%.

Note 2: Characterized, not tested at manufacturing.



## **Recommended Operating Conditions**

Symbol	Description	Min	Max	Unit
V <sup>+</sup>	Positive DC Bus Input Voltage		400	V
V <sub>S1,2,3</sub>	High Side Floating Supply Offset Voltage	(Note 3)	400	V
V <sub>B1,2,3</sub>	High Side Floating Supply Voltage	V <sub>S</sub> +12	V <sub>S</sub> +20	V
V <sub>CC</sub>	Low Side and Logic Supply Voltage	12	16.5	V
V <sub>IN</sub>	Logic Input Voltage	СОМ	Vcc	V
Fp	PWM Carrier Frequency		20	kHz

The Input/Output logic diagram is shown in Figure 1. For proper operation the module should be used within the recommended conditions. All voltages are absolute referenced to COM. The  $V_S$  offset is tested with all supplies biased at 15V differential.

Note 3: Logic operational for V<sub>s</sub> from COM-8V to COM+500V. Logic state held for V<sub>s</sub> from COM-8V to COM-V<sub>BS</sub>.

#### **Static Electrical Characteristics**

 $(V_{CC}\text{-COM}) = (V_B\text{-}V_S) = 15 \text{ V}$ .  $T_A = 25^{\circ}\text{C}$  unless otherwise specified. The  $V_{IN}$  and  $I_{IN}$  parameters are referenced to  $V_{SS}$  and are applicable to all six channels. The  $V_{CCUV}$  parameters are referenced to  $V_S$ .

Symbol	Description	Min	Тур	Max	Units	Conditions
BV <sub>DSS</sub>	Drain-to-Source Breakdown Voltage	500			V	T <sub>J</sub> =25°C, I <sub>LK</sub> =250uA
I <sub>LKH</sub>	Leakage Current of High Side FET		10		μA	T <sub>J</sub> =25°C, V <sub>DS</sub> =500V
I <sub>LKL</sub>	Leakage Current of Low Side FET Plus Gate Drive IC		15		μA	T <sub>J</sub> =25°C, V <sub>DS</sub> =500V
D	Drain to Course ON Desistance		1.5	1.7	0	T <sub>J</sub> =25°C, V <sub>CC</sub> =10V, Id = 2A
R <sub>DS(ON)</sub>	Drain to Source ON Resistance		3		Ω	T <sub>J</sub> =150°C, V <sub>CC</sub> =10V, Id = 2A (Note 4)
V <sub>SD</sub>	Diode Forward Voltage		0.85		V	T <sub>J</sub> =25°C, Id = 2A
V <sub>HIN/LIN</sub>	Logic "1" input voltage for HIN and LIN	2.2			V	
V <sub>HIN/LIN</sub>	Logic "0" input voltage for HIN and LIN			0.8	V	
$\begin{matrix} V_{CCUV+,} \\ V_{BSUV+} \end{matrix}$	$V_{\text{CC}}$ and $V_{\text{BS}}$ Supply Under-Voltage, Positive Going Threshold	8	8.9	9.8	V	
V <sub>CCUV-,</sub> V <sub>BSUV-</sub>	$V_{\text{CC}}$ and $V_{\text{BS}}$ supply Under-Voltage, Negative Going Threshold	6.9	7.7	8.5	V	
V <sub>CCUVH</sub> , V <sub>BSUVH</sub>	V <sub>CC</sub> and V <sub>BS</sub> Supply Under-Voltage Lock-Out Hysteresis		0.7		٧	
I <sub>QBS</sub>	Quiescent V <sub>BS</sub> Supply Current V <sub>IN</sub> =0V		45	70	μΑ	
I <sub>QCC</sub>	Quiescent V <sub>CC</sub> Supply Current V <sub>IN</sub> =0V		1100	3000	μΑ	
I <sub>IN+</sub>	Input Bias Current V <sub>IN</sub> =4V		5	20	μΑ	
I <sub>IN-</sub>	Input Bias Current V <sub>IN</sub> =0V			2	μΑ	
R <sub>BR</sub>	Internal Bootstrap Equivalent Resistor Value		200		Ω	T <sub>J</sub> =25°C

Note 4: Characterized, not tested at manufacturing





## **Dynamic Electrical Characteristics**

 $(V_{CC}\text{-COM}) = (V_{B}\text{-}V_{S}) = 15 \text{ V}. T_{A} = 25^{\circ}\text{C}$  unless otherwise specified.

Symbol	Description	Min	Тур	Max	Units	Conditions
T <sub>ON</sub>	Input to Output Propagation Turn-On Delay Time		0.9	1.5	μs	1 4mA V <sup>†</sup> 50V
T <sub>OFF</sub>	Input to Output Propagation Turn-Off Delay Time		0.9	1.5	μs	I <sub>D</sub> =1mA, V <sup>+</sup> =50V
DT	Built-in Dead Time		300		ns	
T <sub>FIL,IN</sub>	Input Filter Time (HIN, LIN)		300		ns	

#### **FREDFET Avalanche Characteristics**

Symbol	Description	Min	Тур	Max	Units	Conditions
EAS	Single Pulse Avalanche Energy (Note 5)		209		mJ	T <sub>J</sub> =25°C, L=9.5mH, VDD=150V, IAS=6.7A

Note 5: Characterized using TO-220 packaged device

#### **Thermal and Mechanical Characteristics**

Symbol	Description	Min	Тур	Max	Units	Conditions
R <sub>th(J-CT)</sub>	Total Thermal Resistance Junction to Case Top (Note 6)		25		°C/W	
R <sub>th(J-CB)</sub>	Total Thermal Resistance Junction to Case Bottom (Note 6)		1.55		°C/W	

Note 6: Calculated

#### **Qualification Information**†

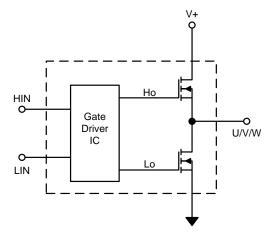
Qualification Level		Industrial <sup>††</sup>
Moisture Sensitivity Level		MSL3 <sup>†††</sup>
ESD	Machine Model	Class B
ESD	Human Body Model	Class 1C
RoHS Compliant		Yes

- Qualification standards can be found at International Rectifier's web site <a href="http://www.irf.com/">http://www.irf.com/</a> †
- †† Higher qualification ratings may be available should the user have such requirements. Please contact your International Rectifier sales representative for further information.
- Higher MSL ratings may be available for the specific package types listed here. Please contact your ††† International Rectifier sales representative for further information.





## **Input-Output Logic Level Table**

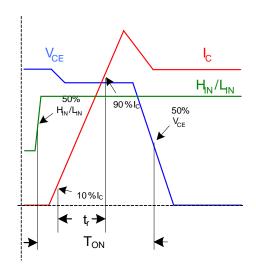


HIN	LIN	U,V,W
HI	LO	V+
LO	HI	0
HI	HI	**
LO	LO	*

<sup>\*</sup> V+ if motor current is flowing into VS, 0 if current is flowing out of VS into the motor winding

\*\* Anti Shoot-through protection active (LO, HO are switched off)

# **Referenced Figures**





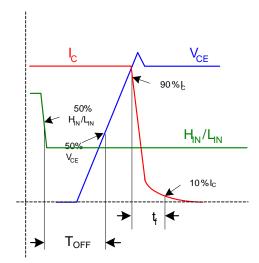


Figure 1b. Input to Output propagation turn-off delay time.



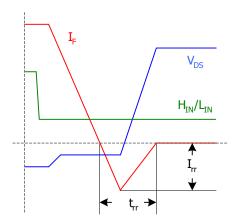
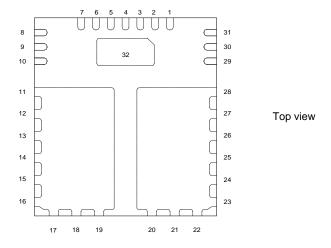


Figure 1c. Diode Reverse Recovery.

Figure 1. Switching Parameter Definitions

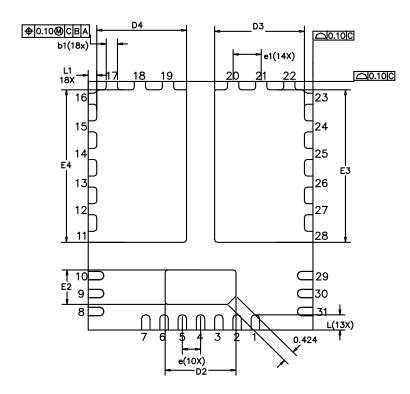
# **Module Pin-Out Description**

Pin	Name	Description
1, 4, 7, 32	СОМ	Low Side Gate Drive Return
2	VCC	15V Gate Drive Supply
3	HIN	Logic Input for High Side (Active High)
5	LIN	Logic Input for Low Side (Active High)
6	NC	Not Connected
8, 9, 10	V-	Low Side Source Connection
11 – 19	VS	Phase Output
20 – 28	V+	DC Bus
29 – 30	VS	Phase Output (-ve Bootstrap Cap Connection)
31	VB	High Side Floating Supply (+ve Bootstrap Cap Connection)
32	-	To be connected to COM





# Package Outline IRSM807-045MH (Bottom View), 1 of 2

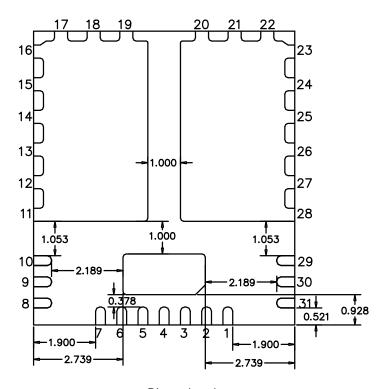


SYMBOL	DIMENSIONS IN MILLIMETER					
	MIN.	NOM.	MAX.			
Α	0.800	0.900	1.000			
A1	0.000		0.050			
А3	0.2	203 REF				
Ь	0.250	0.300	0.350			
b1	0.350	0.400	0.450			
D	7.900	8.000	8.100			
Ε	8.900	9.000	9.100			
D2	2.472	2.522	2.572			
E2	1.197	1.247	1.297			
D3	3.147	3.197	3.247			
E3	5.472	5.522	5.572			
D4	3.147	3.197	3.247			
E4	5.472	5.522	5.572			
е	0.650 BSC					
e1	1.000 BSC					
e2	1.403 BSC					
е3	2	318 BS	С			
L	0.500		0.600			
L1	0.253	0.303	0.353			

Dimensions in mm



# Package Outline IRSM807-045MH (Bottom View), 2 of 2

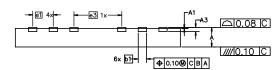


Dimensions in mm

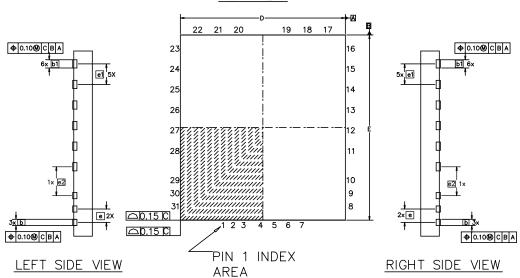


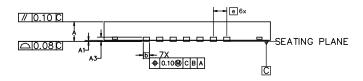
# Package Outline IRSM807-045MH (Top & Side View)

## BACK SIDE VIEW



#### TOP VIEW





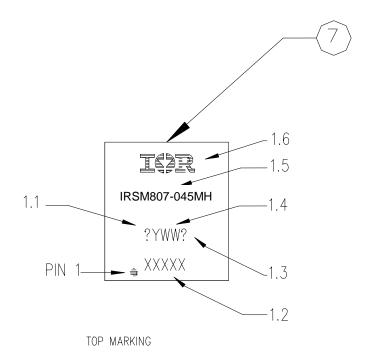
## FRONT SIDE VIEW

ا ہے ا	DIMENSIONS				E2	1.197	1.247	1.297
SYMBOL	M	IN LLIMETE	P		D3	3.147	3.197	3.247
ίn					E3	5.472	5.522	5.572
	MIN.	NOM.	MAX.			7 1 4 7	7 107	7.047
Α	0.800	0.900	1,000		D4	3.147	3.197	3.247
^		0.300			F4	5.472	5.522	5.572
A1	0.000		0.050					
А3	0.	203 REF	-	1	e	0.	650 BS	C
					e1	1.000 BSC		
b	0.250	0.300	0.350			1.5	000 D3	<u> </u>
b1	0.350	0.400	0.450		e2	1.403 BSC		C
D	7.900	8.000	8.100	,	е3	2.318 BSC		С
Ε	8.900	9.000	9.100		Г	0.500 0.550 0.		0.600
D2	2.472	2.522	2.572		L1	0.253	0.303	0.353
							•	

Dimensions in mm



## **Top Marking**



- NOTES, MARKING:
  1.1) SITE CODE: X
  1.2) LAST 4 CHARACTER OF SPN/NANA CODE: XXXX
  1.3) LEADFREE INDICATOR: P

- 1.4) DATE CODE: YWW 1.5) PART NUMBER: IRSM607-105MH

- 1.6) IR LOGO 1.7) MEDIUM: 1.7.1) TOP:LASER
- 1.7.2) BOTTOM: NONE



## **Revision History**



Data and Specifications are subject to change without notice IR WORLD HEADQUARTERS: 233 Kansas St., El Segundo, California 90245, USA Tel: (310) 252-7105 TAC Fax: (310) 252-7903

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